

650V N-Channel MOSFET

General Description

The 65R600Q have been fabricated using an advanced high voltage MOSFET process that is designed to deliver high levels of performance and robustness in popular AC-DC applications.

Features

- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- RoHS Compliant

Product Summary

BVDSS	RDSON	ID
650V	0.6Ω	8A

Applications

- DC-DC Converters
- Power switching application

TO-252/251 Pin Configuration



Type	Package	Marking			
CMD65R600Q	TO-252	CMD65R600Q			
CMU65R600Q	TO-251	CMU65R600Q			

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage 650		V
V_{GS}	Gate-Source Voltage ±30		V
I _D @T _C =25℃	Continuous Drain Current	8	Α
I _D @T _C =100℃	Continuous Drain Current 6		Α
I _{DM}	Pulsed Drain Current	32	Α
EAS	Single Pulse Avalanche Energy 12		mJ
P _D	Total Power Dissipation	25	W
T _{STG}	Storage Temperature Range -55 to 175		°C
TJ	Operating Junction Temperature Range -55 to 175		$^{\circ}$ C

Thermal Data

Symbol	Parameter	Rating	Unit
$R_{ heta JA}$	Thermal Resistance Junction-ambient	75	°C/W
R _{θJC}	Thermal Resistance Junction-case	5	°C/W

CMD65R600Q/CMU65R600Q



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Electrical Characteristics (T_J=25 $^{\circ}$ C , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0 V , I_D =250 μA	650			V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V , I _D =4A			0.6	Ω
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS} = V_{DS} , I_D =250uA	2.0		4.0	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =650V,V _{GS} =0V			1	uA
I _{GSS}	Gate-Source Leakage Current	$V_{GS} = \pm 30V$, $V_{DS} = 0V$			±100	nA
gfs	Forward Transconductance	V _{DS} = 30V , I _D =4A		6		S
R_g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		23		Ω
Q_g	Total Gate Charge	I _D =7.3A		14		
Q_gs	Gate-Source Charge	V _{DS} =520V		4		nC
Q_gd	Gate-Drain Charge	V _{GS} =10V		6		
T _{d(on)}	Turn-On Delay Time	V _{DS} =325V, I _D =7.3A		19		
T _r	Rise Time	R _G =25Ω ,V _{GS} =10V		34		ns
$T_{d(off)}$	Turn-Off Delay Time			81		115
T_f	Fall Time			29		
C _{iss}	Input Capacitance			550		
Coss	Output Capacitance	V _{DS} =25V , V _{GS} =0V , f=1MHz		640		pF
C _{rss}	Reverse Transfer Capacitance			28.6		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	V _G =V _D =0V , Force Current			8	Α
I _{SM}	Pulsed Source Current	VG-VD-OV, Force Current			32	Α
V _{SD}	Diode Forward Voltage	V_{GS} =0V , I_{S} =8A , T_{J} =25 $^{\circ}$ C			1.2	V

Note:

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